

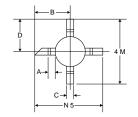
CASCADABLE BROADBAND GaAs MMIC AMPLIFIER DC TO 10GHz

Typical Applications

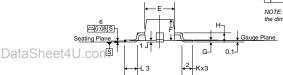
- Narrow and Broadband Commercial and Military Radio Designs
- Linear and Saturated Amplifiers
- Gain Stage or Driver Amplifiers for MWRadio/Optical Designs (PTP/PMP/ LMDS/UNII/VSAT/WLAN/Cellular/DWDM)

Product Description

The NLB-300 cascadable broadband InGaP/GaAs MMIC amplifier is a low-cost, high-performance solution for general purpose RF and microwave amplification needs. This 50Ω gain block is based on a reliable HBT proprietary MMIC design, providing unsurpassed performance for small-signal applications. Designed with an external bias resistor, the NLB-300 provides flexibility and stability. The NLB-300 is packaged in a low-cost, surface-mount plastic package, providing ease of assembly for high-volume tape-and-reel requirements.



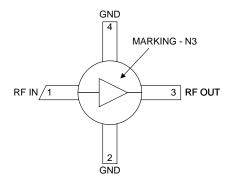
| | Symbol | MIL | LIMET | ERS | INCHES | | | | |
|---|--------|------------|-------|-------|------------|-------|-------|--|--|
| | Syn | Min. | Nom. | Max. | Min. | Nom. | Max. | | |
| | Α | 0.535 REF. | | | 0.021 REF. | | | | |
| | В | 2.39 | 2.54 | 2.69 | 0.094 | 0.100 | 0.106 | | |
| | С | 0.436 | 0.510 | 0.586 | 0.017 | 0.020 | 0.023 | | |
| | D | 2.19 | 2.34 | 2.49 | 0.086 | 0.092 | 0.098 | | |
| | Ε | 1.91 | 2.16 | 2.41 | 0.075 | 0.085 | 0.095 | | |
| | F | 1.32 | 1.52 | 1.72 | 0.052 | 0.060 | 0.068 | | |
| | G | 0.10 | 0.15 | 0.20 | 0.004 | 0.006 | 0.008 | | |
| | н | 0.535 | 0.660 | 0.785 | 0.021 | 0.026 | 0.031 | | |
| 1 | J | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 | | |
| 2 | ĸ | 0.65 | 0.75 | 0.85 | 0.025 | 0.029 | 0.033 | | |
| 3 | L | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 | | |
| 4 | М | 4.53 | 4.68 | 4.83 | 0.178 | 0.184 | 0.190 | | |
| 5 | N | 4.73 | 4.88 | 5.03 | 0.186 | 0.192 | 0.198 | | |



Package Style: Micro-X, 4-Pin, Plastic

Optimum Technology Matching® Applied

☐ Si BJT GaAs HBT GaAs MESFET ☐ Si Bi-CMOS SiGe HBT ☐ Si CMOS InGaP/HBT GaN HEMT SiGe Bi-CMOS



Functional Block Diagram

Features

- Reliable, Low-Cost HBT Design
- 13.0dB Gain, +11.1dBm P1dB@2GHz
- High P1dB of +14.1dBm @ 6.0GHz and
 - +12.7dBm@10.0GHz
- Single Power Supply Operation
- 50Ω I/O Matched for High Freq. Use

Ordering Information

NLB-300 Cascadable Broadband GaAs MMIC Amplifier DC to

10 GHz

NLB-300-T1 or -T3Tape & Reel, 1000 or 3000 Pieces (respectively)

NLB-300-E Fully Assembled Evaluation Board

Extended Frequency InGaP Amp Designer's Tool Kit nc. Tel (336) 664 1233 NBB-X-K1 RF Micro Devices, Inc. 7628 Thorndike Road Fax (336) 664 0454

Greensboro, NC 27409, USA http://www.rfmd.com

Rev A7 040409

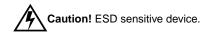
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4-131

Absolute Maximum Ratings

| Parameter | Rating | Unit |
|-----------------------|-------------|------|
| RF Input Power | +20 | dBm |
| Power Dissipation | 300 | mW |
| Device Current | 70 | mA |
| Channel Temperature | 200 | °C |
| Operating Temperature | -45 to +85 | °C |
| Storage Temperature | -65 to +150 | °C |

Exceeding any one or a combination of these limits may cause permanent damage.



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| Daramatar | Specification | | | Unit | Condition | |
|---|---------------|----------------|------------|-------|---|--|
| Parameter | Min. | Min. Typ. Max. | | Unit | Condition | |
| Overall | | | | | V_D =+3.8V, I_{CC} =50mA, Z_0 =50 Ω , T_A =+25°C | |
| Small Signal Power Gain, S21 | 12.0 | 13.0 | | dB | f=0.1 GHz to 1.0 GHz | |
| | | 10.7 | | dB | f=1.0GHz to 4.0GHz | |
| | | 8.9 | | dB | f=4.0GHz to 6.0GHz | |
| | 8.5 | 8.9 | | dB | f=6.0GHz to 10.0GHz | |
| | | 8.5 | | dB | f=10.0GHz to 12.0GHz | |
| Gain Flatness, GF | | ±0.1 | | dB | f=5.0GHz to 10.0GHz | |
| Input VSWR | | 2.2:1 | | | f=0.1 GHz to 4.0 GHz | |
| | | 2.8:1 | | | f=4.0GHz to 7.0GHz | |
| | | 2.0:1 | | | f=7.0GHz to 12.0GHz | |
| Output VSWR | | 2.2:1 | | | f=0.1 GHz to 4.0 GHz | |
| | | 2.9:1 | | | f=4.0GHz to 7.0GHz | |
| | | 2.4:1 Data | Sheet4U | com | f=7.0GHz to 12.0GHz | |
| Output Power @ | | | 1011001-10 | | | |
| -1dB Compression, P1dB | | 11.1 | | dBm | f=2.0GHz | |
| | | 14.1 | | dBm | f=6.0GHz | |
| l | | 12.7 | | dBm | f=10.0GHz | |
| Noise Figure, NF | | 4.9 | | dB | f=3.0GHz | |
| Third Order Intercept, IP3 | | +28.6 | | dBm | f=2.0GHz | |
| B 1 1 // 040 | | +27.0 | | I.D. | f=6.0GHz | |
| Reverse Isolation, S12 | 0.0 | -16 | 4.0 | dB | f=0.1 GHz to 20.0 GHz | |
| Device Voltage, V _D | 3.6 | 3.8 | 4.2 | V | | |
| Gain Temperature Coefficient, $\delta G_T/\delta T$ | | -0.0015 | | dB/°C | | |
| MTTF versus Temperature | | | | | | |
| @ I _{CC} =50mA | | | | | | |
| Case Temperature | | 85 | | °C | | |
| Junction Temperature | | 113 | | °C | | |
| MTTF | | >1,000,000 | | hours | | |
| Thermal Resistance | | | | | | |
| θJC | | 147 | | °C/W | $\frac{J_T - T_{CASE}}{V_D \cdot I_{CC}} = \theta_{JC}(^{\circ}C/Watt)$ | |

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4-132 Rev A7 040409

| Pin | Function | Description | Interface Schematic |
|-----|----------|---|---------------------|
| 1 | RF IN | RF input pin. This pin is NOT internally DC-blocked. A DC-blocking capacitor, suitable for the frequency of operation, should be used in most applications. DC coupling of the input is not allowed, because this will override the internal feedback loop and cause temperature instability. | |
| 2 | GND | Ground connection. For best performance, keep traces physically short and connect immediately to ground plane. | |
| 3 | RF OUT | RF output and bias pin. Biasing is accomplished with an external series resistor and choke inductor to V_{CC} . The resistor is selected to set the DC current into this pin to a desired level. The resistor value is determined by the following equation: $R = \frac{(V_{CC} - V_{DEVICE})}{I_{CC}}$ Care should also be taken in the resistor selection to ensure that the current into the part never exceeds maximum datasheet operating current over the planned operating temperature. This means that a resistor between the supply and this pin is always required, even if a supply near 5.0V is available, to provide DC feedback to prevent thermal runaway. Because DC is present on this pin, a DC-blocking capacitor, suitable for the frequency of operation, should be used in most applications. The supply side of the bias network should also be well bypassed. | RF IN O |
| 4 | GND | Same as pin 2. | |

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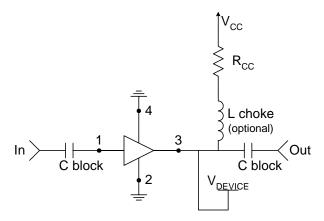
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Rev A7 040409 4-133

Typical Bias Configuration

Application notes related to biasing circuit, device footprint, and thermal considerations are available on request.



| Recommended Bias Resistor Values | | | | | | |
|--------------------------------------|----|----|-----|-----|-----|-----|
| Supply Voltage, V _{CC} (V) | 5 | 8 | 10 | 12 | 15 | 20 |
| Bias Resistor, R_{CC} (Ω) | 22 | 82 | 122 | 162 | 222 | 322 |

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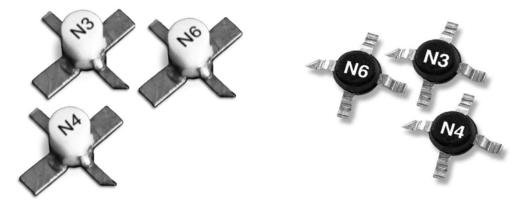
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4-134 Rev A7 040409

Extended Frequency InGaP Amplifier Designer's Tool Kit NBB-X-K1

This tool kit was created to assist in the design-in of the RFMD NBB- and NLB-series InGap HBT gain block amplifiers. Each tool kit contains the following.

- 5 each NBB-300, NBB-310 and NBB-400 Ceramic Micro-X Amplifiers
- 5 each NLB-300, NLB-310 and NLB-400 Plastic Micro-X Amplifiers
- 2 Broadband Evaluation Boards and High Frequency SMA Connectors
- Broadband Bias Instructions and Specification Summary Index for ease of operation



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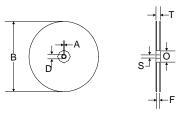
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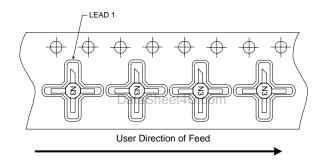
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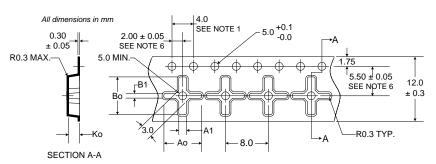
Tape and Reel Dimensions

All Dimensions in Millimeters



| | 14.732 mm (7") REEL | Plastic, Micro-X | | | |
|--------|-----------------------|------------------|------------------|---------------------|--|
| | ITEMS | SYMBOL | SIZE (mm) | SIZE (inches) | |
| | Diameter | В | 178 +0.25/-4.0 | 7.0 +0.079/-0.158 | |
| FLANGE | Thickness | Т | 18.4 MAX | 0.724 MAX | |
| | Space Between Flange | F | 12.8 +2.0 | 0.50 +0.08 | |
| | Outer Diameter | 0 | 76.2 REF | 3.0 REF | |
| HUB | Spindle Hole Diameter | S | 13.716 +0.5/-0.2 | 0.540 +0.020/-0.008 | |
| пов | Key Slit Width | Α | 1.5 MIN | 0.059 MIN | |
| | Key Slit Diameter | D | 20.2 MIN | 0.795 MIN | |





NOTES:

- 1. 10 sprocket hole pitch cumulative tolerance ±0.2.
- Camber not to exceed 1 mm in 100 mm.
 Material: PS+C.
- 4. Ao and Bo measured on a plane 0.3 mm above the bottom of the pocket.5. Ko measured from a plane on the inside bottom of the pocket to the surface of the carrier.
- 6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

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Ao = 7.0 MM

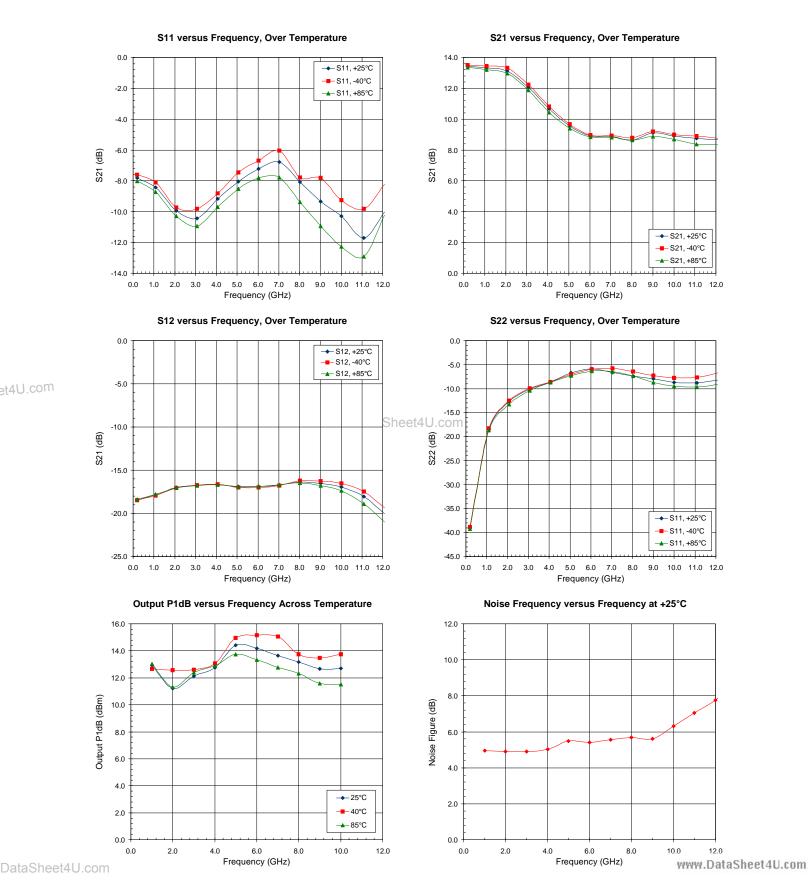
A1 = 1.8 MM

Bo = 7.0 MM B1 = 1.3 MM

Ko = 2.1 MM

4-136 Rev A7 040409 et4U.com

NLB-300



Rev A7 040409 4-137

Note: The s-parameter gain results shown include device performance as well as evaluation board and connector loss variations. The insertion losses of the evaluation board and connectors are as follows:

1 GHz to 4 GHz=-0.06 dB 5 GHz to 9 GHz=-0.22 dB 10 GHz to 14 GHz=-0.50 dB 15 GHz to 20 GHz=-1.08 dB

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4-138 Rev A7 040409